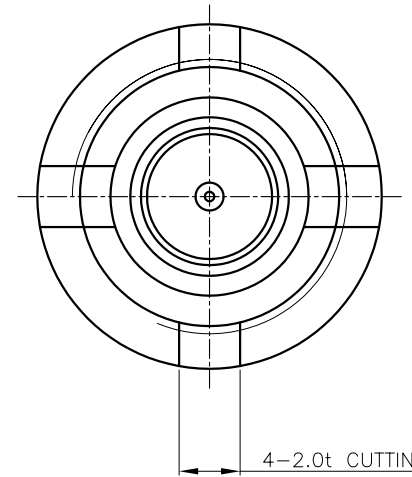
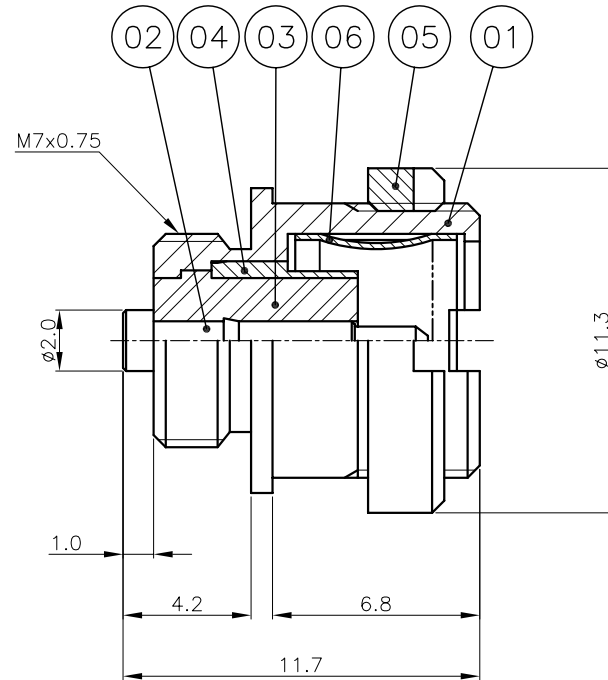


REVISION		
REV	DESCRIPTION	DATE
IR	Initial Registration	2010.05.18.



6	SPRING	1	BeCu	Gold Plate	DPS00001-5/1
5	NUT	1	MBsBD	Nickel Plate	DNT00070-5/1
4	INSERT	1	MBsBD	Nickel Plate	DIB00007-5/1
3	INSULATOR	1	TEFLON		DIN01790-N/1
2	CONTACT	1	MBsBD	Gold Plate	DCT02285-5/1
1	BODY	1	MBsBD	Nickel Plate	DBD02757-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2010. 05. 18.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	Y.H.CHOI	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA Trans(SCREW) PUSH SOLDER END
		DRAWN BY	I.C.KIM	
FINISH		SCALE	UNIT	A4 DWG NO. CN02558-7/1 REVISION I R SHEET 1 of 1
		4/1	mm	